

### ● General Description

The AGM025N13LL combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

### ● Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

### ● Application

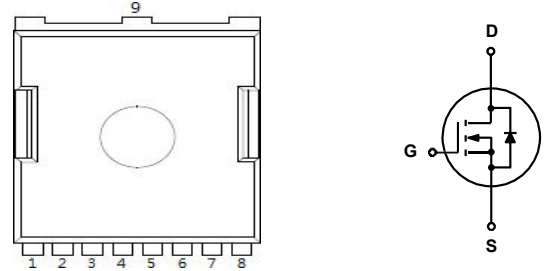
- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

### Package Marking and Ordering Information

### Product Summary

| BVDSS | RDSON | ID   |
|-------|-------|------|
| 135V  | 2.9mΩ | 305A |

### TOLL-8L Pin Configuration



| Pin           | Description |
|---------------|-------------|
| 1             | Gate(G)     |
| 2,3,4,5,6,7,8 | Source(S)   |
| 9             | Drain(D)    |

| Device Marking | Device      | Device Package | Reel Size | Tape width | Quantity |
|----------------|-------------|----------------|-----------|------------|----------|
| AGM025N13LL    | AGM025N13LL | TOLL-8L        | ----      | ----       | 2000     |

Table 1. Absolute Maximum Ratings (TA=25°C)

| Symbol      | Parameter   | Value      | Unit |
|-------------|---|------------|------|
| VDS         | Drain-Source Voltage (VGS=0V)                     | 135        | V    |
| VGS         | Gate-Source Voltage (VDS=0V)                      | ±20        | V    |
| ID          | Drain Current-Continuous(Tc=25°C) (Note 1)        | 305        | A    |
|             | Drain Current-Continuous(Tc=100°C)                | 215        | A    |
| IDM (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 2) | 600        | A    |
| PD          | Maximum Power Dissipation(Tc=25°C)                | 357        | w    |
|             | Maximum Power Dissipation(Tc=100°C)               | 143        | w    |
| EAS         | Avalanche energy (Note 3)                         | 1500       | mJ   |
| TJ,TSTG     | Operating Junction and Storage Temperature Range  | -55 To 175 | °C   |

Table 2. Thermal Characteristic

| Symbol | Parameter   | Typ | Max  | Unit |
|--------|---|-----|------|------|
| RθJA   | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | --- | 61   | °C/W |
| RθJC   | Thermal Resistance Junction-Case <sup>1</sup>                   | --- | 0.35 | °C/W |

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

| Symbol                                    | Parameter                        | Conditions                           | Min | Typ  | Max  | Unit |
|---|----------------------------------|--------------------------------------|-----|------|------|------|
| <b>On/Off States</b>                      |                                  |                                      |     |      |      |      |
| BVDSS                                     | Drain-Source Breakdown Voltage   | VGS=0V ID=250μA                      | 135 | --   | --   | V    |
| IDSS                                      | Zero Gate Voltage Drain Current  | VDS=135V,VGS=0V                      | --  | --   | 1    | μA   |
| IGSS                                      | Gate-Body Leakage Current        | VGS=±20V,VDS=0V                      | --  | --   | ±100 | nA   |
| VGS(th)                                   | Gate Threshold Voltage           | VDS=VGS,ID=250μA                     | 2.0 | --   | 4.0  | V    |
| gFS                                       | Forward Transconductance         | VDS=5V,ID=25A                        | --  | --   | --   | S    |
| RDS(on)                                   | Drain-Source On-State Resistance | VGS=10V, ID=50A                      | --  | 2.9  | 3.5  | mΩ   |
|   |                                  | VGS=4.5V, ID=25A                     | --  | 3.5  | 4.5  | mΩ   |
| <b>Dynamic Characteristics</b>            |                                  |                                      |     |      |      |      |
| Ciss                                      | Input Capacitance                | VDS=70V,VGS=0V,<br>F=1MHZ            | --  | 8362 | --   | pF   |
| Coss                                      | Output Capacitance               |                                      | --  | 860  | --   | pF   |
| Crss                                      | Reverse Transfer Capacitance     |                                      | --  | 14.6 | --   | pF   |
| Rg  | Gate resistance                  | VGS=0V,<br>VDS=0V,f=1.0MHz           | --  | --   | --   | Ω    |
| <b>Switching Times</b>                    |                                  |                                      |     |      |      |      |
| td(on)                                    | Turn-on Delay Time               | VGS=10V,VDS=70V<br>ID=50A, RGEN=4.5Ω | --  | 1.0  | --   | nS   |
| tr  | Turn-on Rise Time                |                                      | --  | 33   | --   | nS   |
| td(off)                                   | Turn-Off Delay Time              |                                      | --  | 95   | --   | nS   |
| tf  | Turn-Off Fall Time               |                                      | --  | 75   | --   | nS   |
| Qg  | Total Gate Charge                | VGS=10V, VDS=70V,<br>ID=50A          | --  | 1387 | --   | nC   |
| Qgs                                       | Gate-Source Charge               |                                      | --  | 34   | --   | nC   |
| Qgd                                       | Gate-Drain Charge                |                                      | --  | 32   | --   | nC   |
| <b>Source-Drain Diode Characteristics</b> |                                  |                                      |     |      |      |      |
| ISD                                       | Source-Drain Current(Body Diode) |                                      | --  | --   | 305  | A    |
| VSD                                       | Forward on Voltage               | VGS=0V,IS=50A                        | --  | --   | 1.3  | V    |
| trr                                       | Reverse Recovery Time            | IF=50A , dI/dt=100A/μs ,<br>TJ=25°C  | --  | 130  | --   | ns   |
| Qrr                                       | Reverse Recovery Charge          |                                      | --  | 500  | --   | nc   |

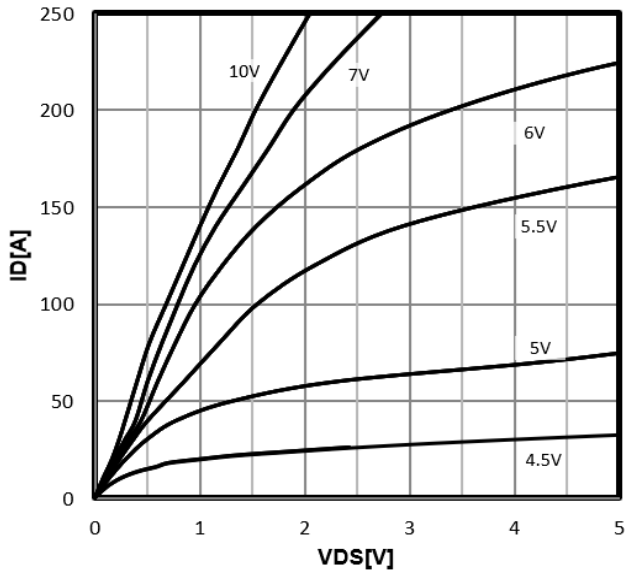
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

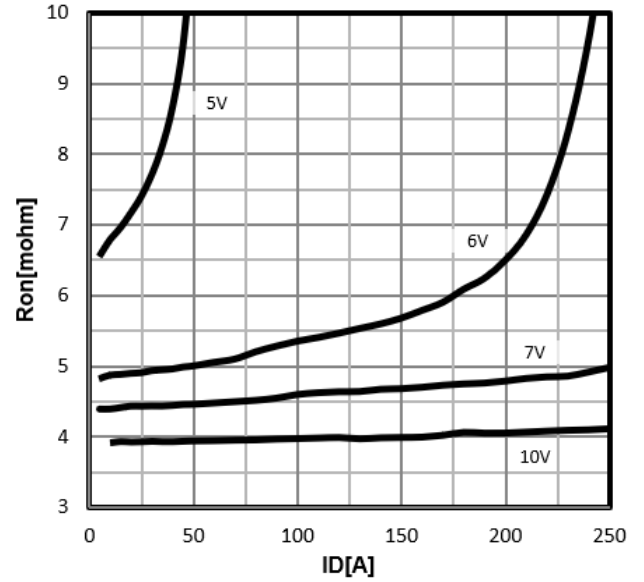
Notes 3.EAS condition: TJ=25°C

**Typ. output characteristics**

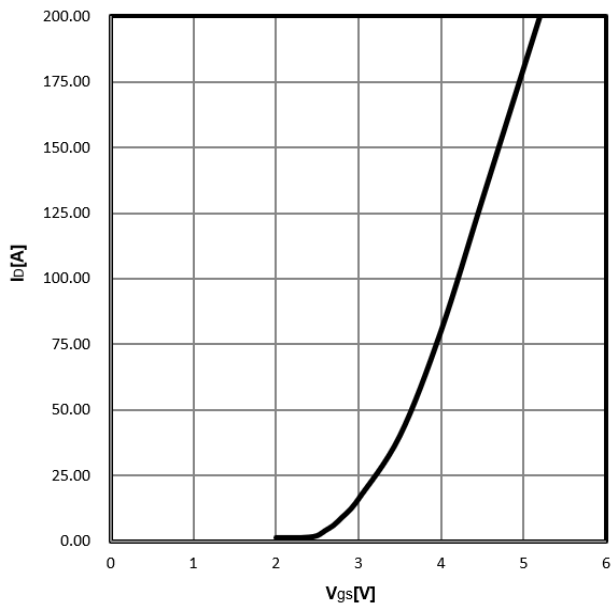
$$I_D = f(V_{DS})$$


**Typ. drain-source on resistance**

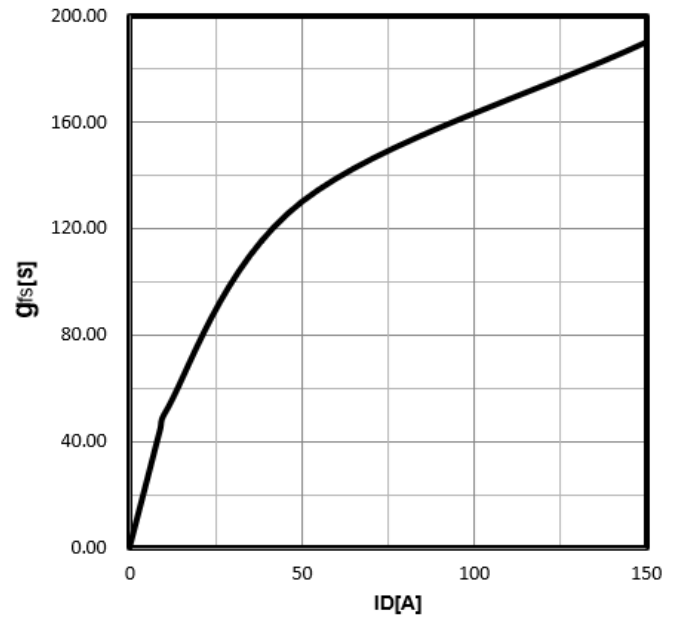
$$R_{DS(on)} = f(I_D)$$


**Typ. transfer characteristics**

$$I_D = f(V_{GS})$$

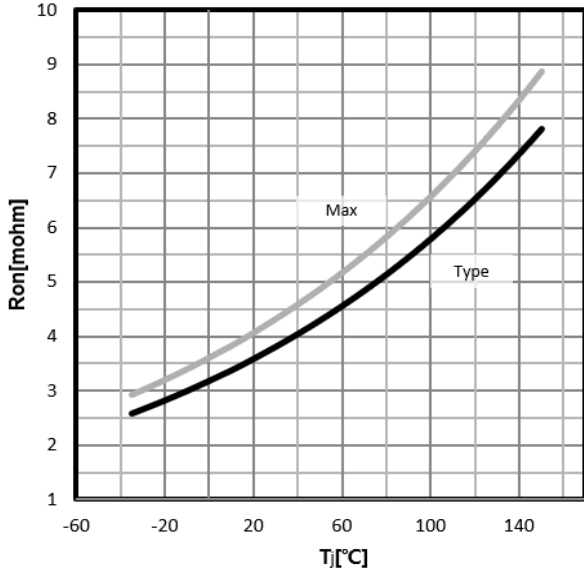

**Typ. forward transconductance**

$$g_{fs} = f(I_D)$$

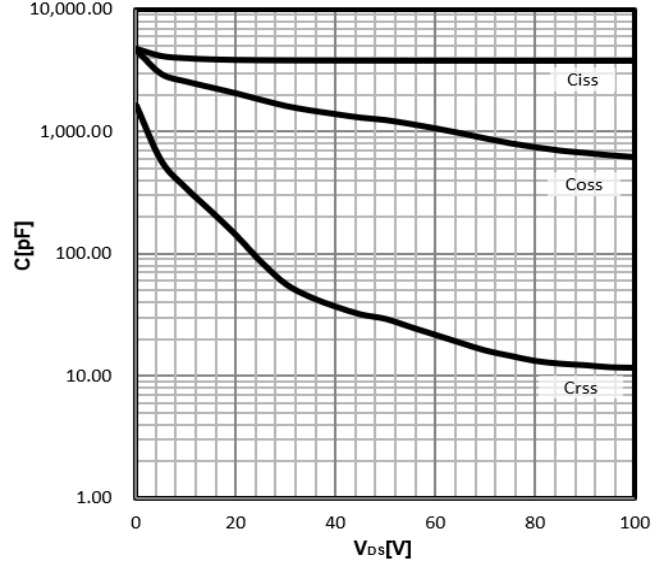


**Drain-source on-state resistance**

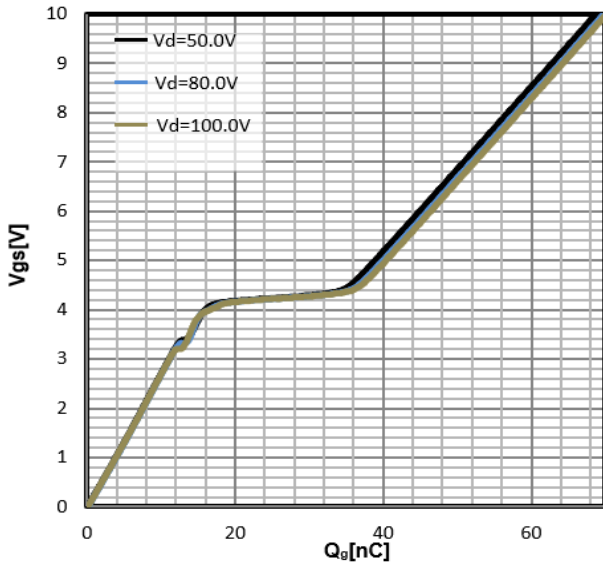
$$R_{DS(on)} = f(T_j); I_D = 80A; V_{GS} = 10V$$


**Typ. capacitances**

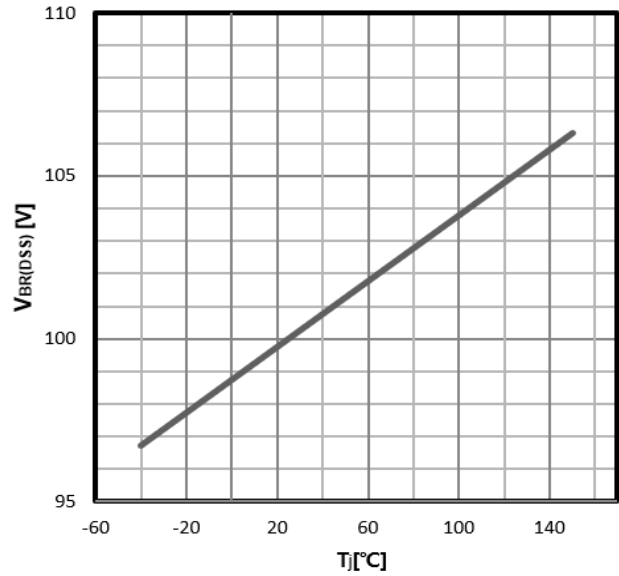
$$C = f(V_{DS}); V_{GS} = 0V; f = 1MHz$$


**Typ. gate charge**

$$V_{GS} = f(Q_{gate}); I_D = 20A$$

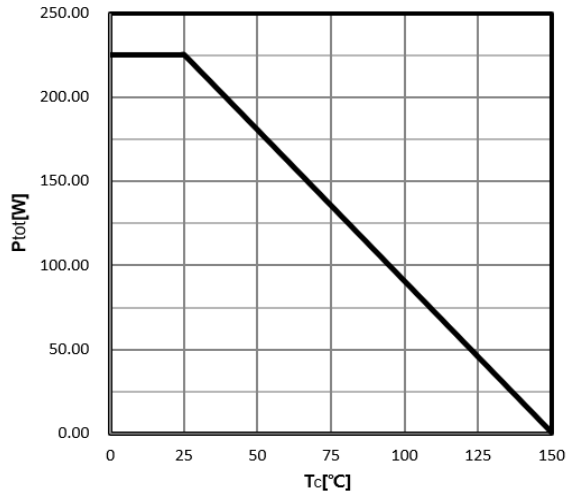

**Drain-source breakdown voltage**

$$V_{BR(DSS)} = f(T_j); I_D = 250\mu A$$

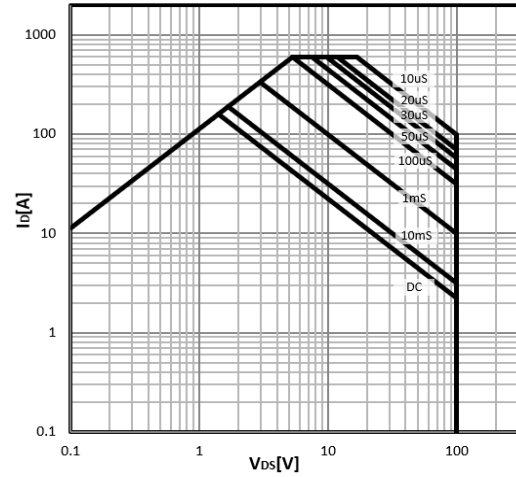


**Power Dissipation**

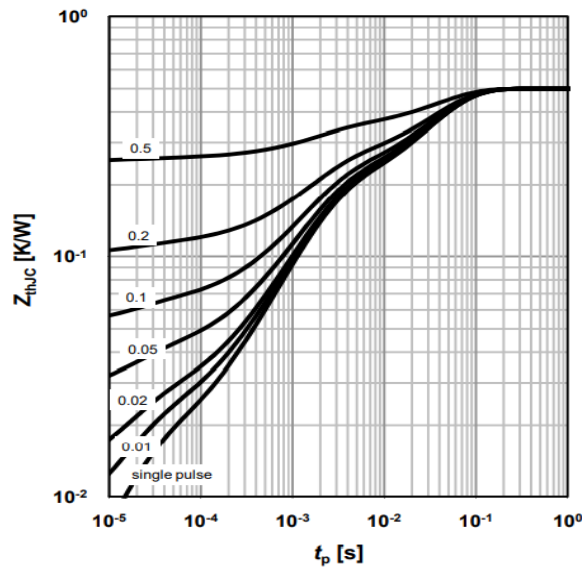
$$P_{tot}=f(T_c)$$

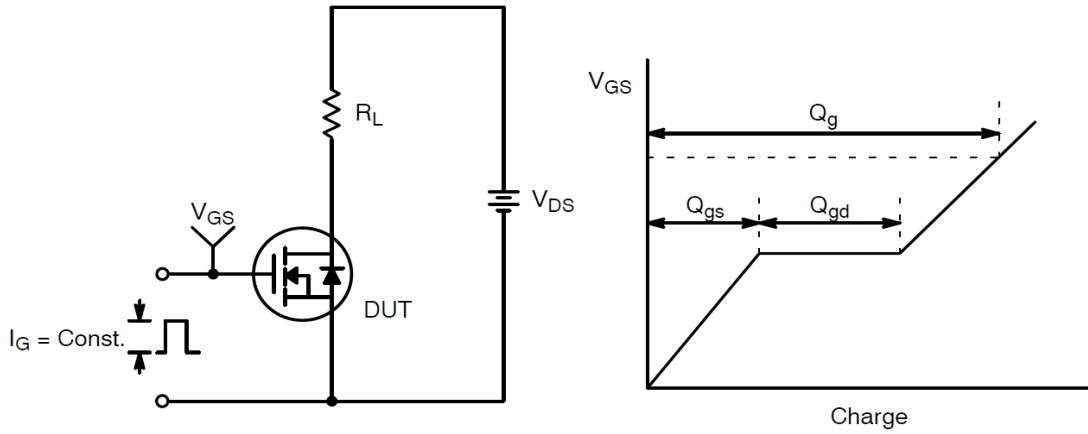
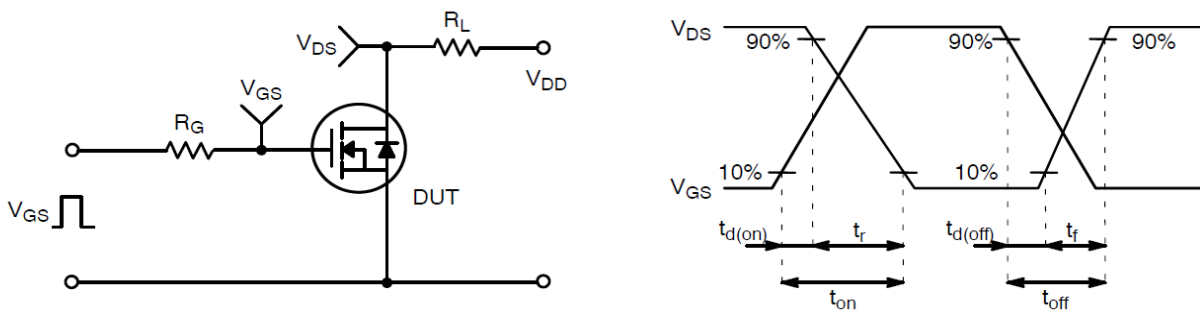
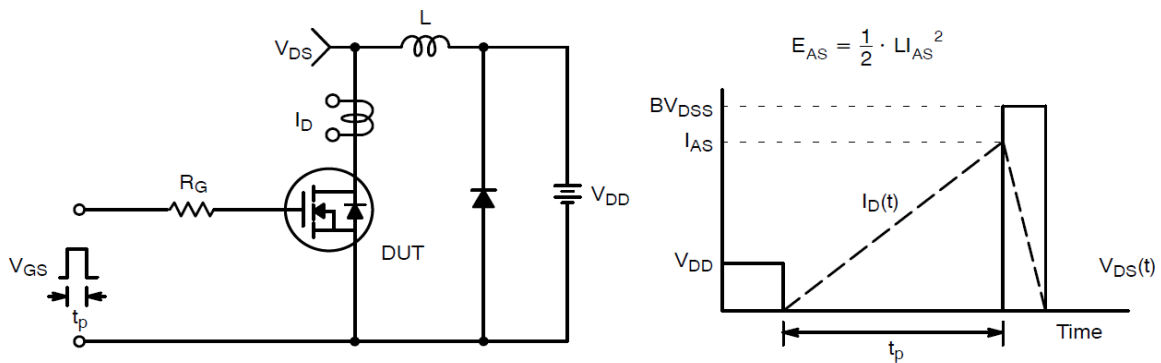

**Safe operating area**

$$I_D=f(V_{DS})$$


**Max. transient thermal impedance**

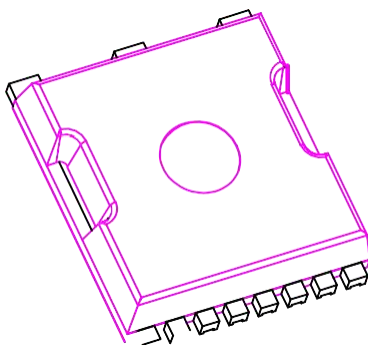
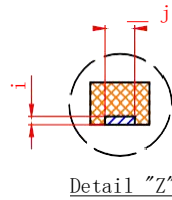
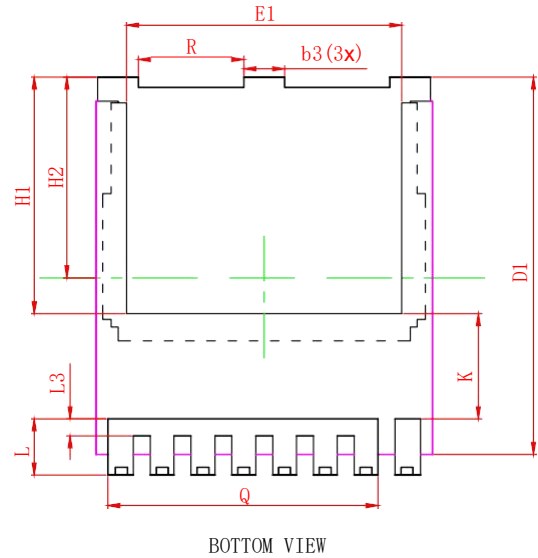
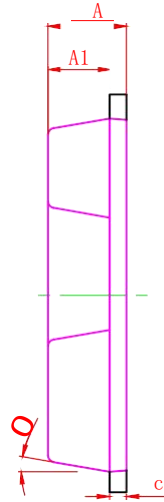
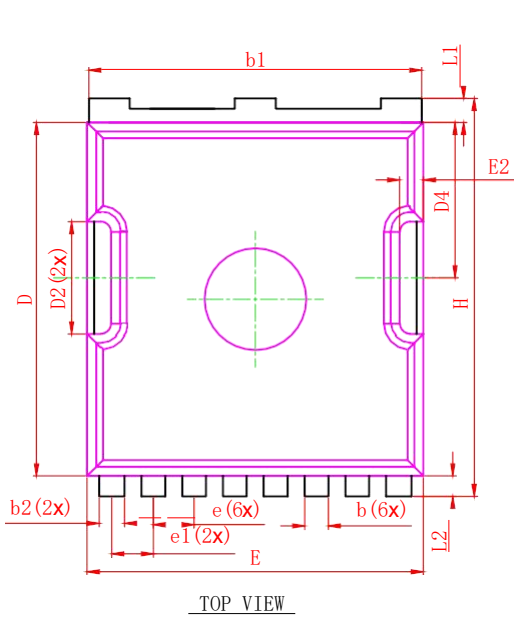
$$Z_{thJC}=f(t_p)$$



**Test Circuit and Waveform:**

**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

**Unclamped Inductive Switching Test Circuit & Waveforms**

# Package Dimensions

## TOLL-8L Package



| SYMBOL | MILLIMETER |        |        |
|--------|------------|--------|--------|
|        | MIN.       | NOM.   | MAX.   |
| A      | 2.200      | 2.300  | 2.400  |
| A1     | 1.700      | 1.800  | 1.900  |
| b      | 0.600      | 0.700  | 0.800  |
| b1     | 9.700      | 9.800  | 9.900  |
| b2     | 0.650      | 0.750  | 0.850  |
| b3     | 1.100      | 1.200  | 1.300  |
| c      | 0.400      | 0.500  | 0.600  |
| D      | 10.300     | 10.400 | 10.500 |
| D1     | 11.000     | 11.100 | 11.200 |
| D2     | 3.200      | 3.300  | 3.400  |
| D4     | 4.470      | 4.570  | 4.670  |
| E      | 9.800      | 9.900  | 10.000 |
| E1     | 8.000      | 8.100  | 8.200  |
| E2     | 0.500      | 0.600  | 0.700  |
| e      | 1.200 BSC  |        |        |
| e1     | 1.225 BSC  |        |        |
| H      | 11.600     | 11.700 | 11.800 |
| H1     | 6.950 BSC  |        |        |
| H2     | 5.900 BSC  |        |        |
| i      | 0.100 REF. |        |        |
| j      | 0.350 REF. |        |        |
| K      | 3.100 REF. |        |        |
| L      | 1.550      | 1.650  | 1.750  |
| L1     | 0.600      | 0.700  | 0.800  |
| L2     | 0.500      | 0.600  | 0.700  |
| L3     | 0.400      | 0.500  | 0.600  |
| Q      | 7.950 REF. |        |        |
| R      | 3.000      | 3.100  | 3.200  |
| Ø      | 10°REE.    |        |        |


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